

## ISOLATED DC-DC CONVERTER CHB150-110S SERIES APPLICATION NOTE



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### 1. Introduction

The CHB150-110S series of DC-DC converters offers 150 watts of output power @ single output voltages of 05, 12, 24VDC with industry standard half-brick. It has a wide (3:1) input voltage range of 66 to 160VDC (110VDC nominal) and 2250VDC basic isolation.

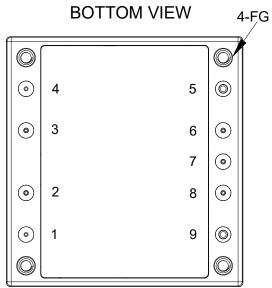
Compliant with EN 50155, EN 45545-2, EN 50121-3-2. High efficiency up to 92.5%, allowing case operating temperature range of -40°C to 100°C. An optional heat sink is available to extend the full power range of the unit. An ideal solution for energy critical systems.

The standard control functions include remote on/off (positive or negative) and +10%, -10% adjustable output voltage.

Fully protected against input UVLO (under voltage lock out), output over-current, output over-voltage and over-temperature and continuous short circuit conditions.

CHB150-110S series is designed primarily for common railway applications of 110V nominal voltage and also suitable for distributed power architectures, telecommunications, battery operated equipment, industrial and mobile equipment application.

## 2. Pin Function Description



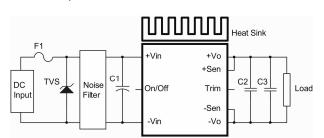
No	Label	Function	Description	Reference
1	+Vin	+V Input	Positive Supply Input	Section 7.1/7.2
2	Remote	On/Off	External Remote On/Off Control	Section 6.5
3	Case	Case	Connected to Base Plate	
4	-Vin	-V Input	Negative Supply Input	Section 7.1/7.2
5	-Vo	-V Output	Negative Power Output	Section 7.3/7.4
6	-Sen	-Sense	Negative Output Remote Sense	Section 6.6
7	Trim	Trim	External Output Voltage Adjustment	Section 6.7
8	+Sen	+Sense	Positive Output Remote Sense	Section 6.6
9	+Vo	+V Output	Positive Power Output	Section 7.3/7.4
		Mounting Insert	Mounting Insert (FG)	Section 9.5

Note: Base plate can be connected to FG through M3 threaded mounting insert. Recommended torque 3Kgf-cm.



## 3. Connection for Standard Use

The connection for standard use is shown below. An external input capacitor (C1) 220uF for all models is recommended to reduce input ripple voltage. External output capacitors (C2, C3) are recommended to reduce output ripple and noise, 10uF solid tantalum and 1uF ceramic capacitor for other models.



Symbol	Component	Reference
F1, TVS	Input fuse, TVS	Section 10.1
C1	External capacitor on input side	Note Section 7.1
C2, C3	External capacitor on the output side	Section 7.3/7.4
Noise Filter	External input noise filter	Section 10.2
Remote On/Off	External Remote On/Off control	Section 6.5
Trim	External output voltage adjustment	Section 6.7
Heat Sink	External heat sink	Section 9.2/9.3/9.4/9.5
+Sense/-Sense		Section 6.6

#### Note:

If the impedance of input line is high, C1 capacitance must be more than above. Use more than two recommended capacitor above in parallel when ambient temperature becomes lower than -20°C.

### 4.Test Set-Up

The basic test set-up to measure parameters such as efficiency and load regulation is shown below. When testing the modules under any transient conditions please ensure that the transient response of the source is sufficient to power the equipment under test. We can calculate:

- Efficiency
- Load regulation and line regulation

The value of efficiency is defined as:

$$\eta = \frac{V_o \times I_o}{V_{in} \times I_{in}} \times 100\%$$

#### Where:

V<sub>o</sub> is output voltage, I<sub>o</sub> is output current, V<sub>in</sub> is input voltage, I<sub>in</sub> is input current

The value of load regulation is defined as:

Load reg. = 
$$\frac{V_{FL} - V_{NL}}{V_{NL}} \times 100\%$$

Where:

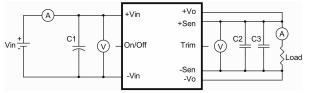
 $V_{\text{FL}}$  is the output voltage at full load  $V_{\text{NL}}$  is the output voltage at no load

The value of line regulation is defined as:  $Line \ reg. = \frac{V_{HL} - V_{LL}}{V_{II}} \times 100\%$ 

Where:

V<sub>HL</sub> is the output voltage of maximum input voltage at full load

 $V_{\mbox{\scriptsize LL}}$  is the output voltage of minimum input voltage at full load



CHB150-110S Series Test Setup

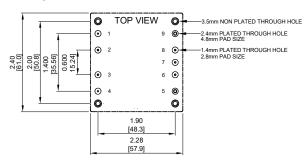
- C1: 220uF/200V ESR<0.14Ω
- C2: 1uF/1210 ceramic capacitor

C3: 10uF solid tantalum capacitor



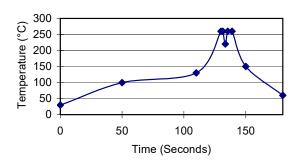
## 5. Recommend Layout, PCB Footprint and Soldering Information

The system designer or end user must ensure that metal and other components in the vicinity of the converter meet the spacing requirements for which the system is approved. Low resistance and inductance PCB layout traces are the norm and should be used where possible. Due consideration must also be given to proper low impedance tracks between power module, input and output grounds.



Clean the soldered side of the module with a brush, prevent liquid from getting into the module. Do not clean by soaking the module into liquid. Do not allow solvent to come in contact with product labels or resin case as this may changed the color of the resin case or cause deletion of the letters printed on the product label. After cleaning, dry the modules well.

The suggested soldering iron is 450°C for up to 5seconds (less than 90W). Furthermore, the recommended soldering profile is shown below.

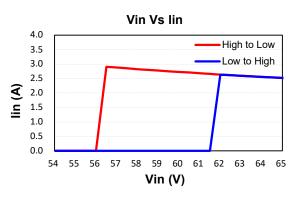


#### Lead Free Wave Soldering Profile

## 6. Features and Functions

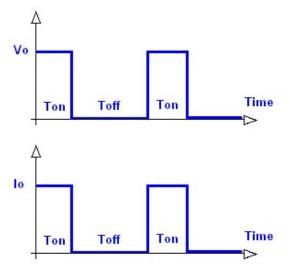
### 6.1 UVLO (Under Voltage Lock Out)

Input under voltage lockout is standard on the CHB150-110S series unit. The unit will shut down when the input voltage drops below a threshold, and the unit will operate when the input voltage goes above the upper threshold.



### 6.2 Over Current/Short Circuit Protection

All models have internal over current and continuous short circuit protection. The unit operates normally once the fault condition is removed. At the point of current limit inception, the converter will go into hiccup mode protection.





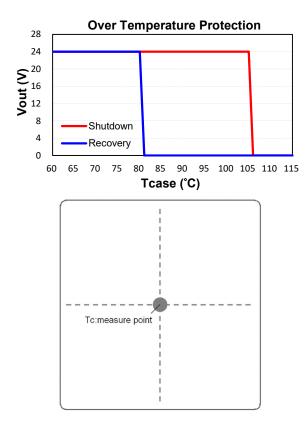
#### 6.3 Output Over Voltage Protection

The output over voltage protection consists of circuitry that internally limits the output voltage. If more accurate output over voltage protection is required, then an external circuit can be used via the remote on/off pin.

**Note**: Please note that device inside the power supply might fail when voltage more than rate output voltage is applied to output pin. This could happen when the customer tests the over voltage protection of unit. OVP can be tested by using the TRIM UP function. Consult us for more information.

### 6.4 Over Temperature Protection

These modules have an over temperature protection circuit to safeguard against thermal damage. Shutdown occurs with the maximum case reference temperature is exceeded. The module will restart when the case temperature falls below over temperature recovery threshold. Please measure case temperature of the center part of aluminum base plate.



### 6.5 Remote On/Off

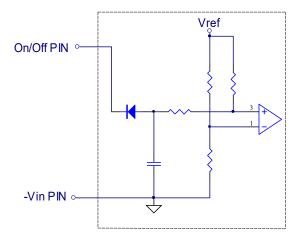
The CHB150-110S series allows the user to switch the module on and off electronically with the remote **on/off** feature. All models are available in "positive logic" and "negative logic" (optional) versions. The converter turns on if the remote **on/off** pin is high (>3.5Vdc to 75Vdc or open circuit). Setting the pin low (0 to<1.8Vdc) will turn the converter off. The signal level of the remote **on/off** input is defined with respect to ground.

If not using the remote **on/off** pin, leave the pin open (converter will be on).

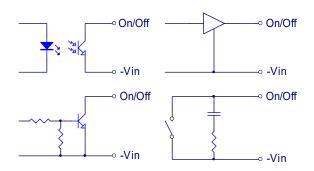
Models with part number suffix "N" are the "negative logic" remote **on/off** version. The unit turns off if the remote **on/off** pin is high (>3.5Vdc to 75Vdc or open circuit). The converter turns on if the **on/off** pin input is low (0 to<1.8Vdc). Note that the converter is off by default.

Logic State (Pin 2)	Negative Logic	Positive Logic
Logic Low	Module on	Module off
Logic High	Module off	Module on

The converter remote **on/off** circuit built-in on input side. The ground pin of input side remote **on/off** circuit is -Vin pin. Inside connection sees below.



#### **Connection Examples See Below**



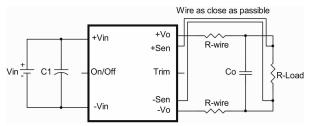


#### 6.6 Output Remote Sensing

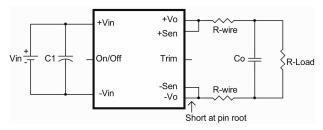
The CHB150-110S series converter has the capability to remotely sense both lines of its output. This feature moves the effective output voltage regulation point from the output of the unit to the point of connection of the remote sense pins. This feature automatically adjusts the real output voltage of the CHB150-110S series in order to compensate for voltage drops in distribution and maintain a regulated voltage at the point of load. The remote-sense voltage range is:

 $\label{eq:constraint} \begin{array}{l} [(+V_{out}) - (-V_{out})] - [(+Sense) - (-Sense)] \\ 10\% \mbox{ of } V_{o\_nominal} \end{array}$ 

When remote sense is in use, the sense should be connected by twisted-pair wire or shield wire. If the sensing patterns short, heave current flows and the pattern may be damaged. Output voltage might become unstable because of impedance of wiring and load condition when length of wire is exceeding 400mm. This is shown in the schematic below.



If the remote sense feature is not to be used, the sense pins should be connected locally. The +Sense pin should be connected to the +Vout pin at the module and the -Sense pin should be connected to the -Vout pin at the module. Wire between +Sense and +Vout and between -Sense and -Vout as short as possible. Loop wiring should be avoided. The converter might become unstable by noise coming from poor wiring. This is shown in the schematic below.



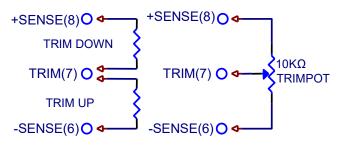
#### Note:

Although the output voltage can be varied (increased or decreased) by both remote sense and trim, the maximum variation for the output voltage is the larger of the two values not the sum of the values. The output power delivered by the module is defined as the voltage at the output terminals multiplied by the output current. Using remote sense and trim can cause the output voltage to increase and consequently increase the power output of the module if output current remains unchanged. Always ensure that the output power of the module remains at or below the maximum rated power. Also be aware that if  $V_{o.set}$  is below nominal value,  $P_{out.max.}$  will also decrease accordingly because  $I_{o.max.}$  is an absolute limit. Thus,  $P_{out.max.} = V_{o.set} \times I_{o.max.}$  is also an absolute limit.

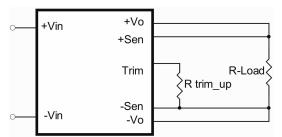


### 6.7 Output Voltage Adjustment

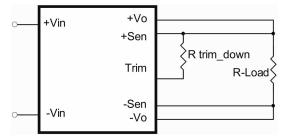
Output may be externally trimmed  $(\pm 10\%)$  with a fixed resistor or an external trim pot as shown (optional). Model specific formulas for calculating trim resistors are available upon request as a separate document.



In order to trim the voltage up or down, one needs to connect the trim resistor either between the trim pin and -Sense for trim-up or between trim pin and +Sense for trim-down. The output voltage trim range is  $(\pm 10\%)$ . This is shown:



Trim-up Voltage Setup



Trim-down Voltage Setup

Table 1 - Trim up and Trim down Resistor Values

Model Number	Output	R1	R2	R3	Vr AA	Vf (V)
	Voltage(V)	(ΚΩ)	(ΚΩ)	(ΚΩ)	vi (v)	VI (V)
CHB150-110S05	5	2.32	3.3	0	2.5	0
CHB150-110S12	12	9.1	51	5.1	2.5	0.46
CHB150-110S24	24	20	100	7.5	2.5	0.46

#### The value of $R_{trim\_up}$ defined as:

For Vo=5V Rtrim\_up decision:

$$Rtrim\_up = \frac{R1Vr}{Vo - Vo\_nom} - R_2 (K\Omega)$$

For others Rtrim\_up decision:

$$Rtrim\_up = \left(\frac{R1(Vr - Vf(\frac{R2}{R2 + R3}))}{Vo - Vo\_nom}\right) - \frac{R2R3}{R2 + R3} (K\Omega)$$

Where:

 $R_{trim\_up}$  is the external resistor in K $\Omega$ .

V<sub>o\_nom</sub> is the nominal output voltage

 $V_{\circ}$  is the desired output voltage

R1, R2, R3 and Vr are internal components

For example, to trim-up the output voltage of 12V module (CHB150-110S12) by 5% to 12.6V,  $R_{trim\_up}$  is calculated as follows:

$$V_{o} - V_{o\_nom} = 12.6 - 12 = 0.6V$$
  
R1 = 9.1 KΩ  
R2 = 51 KΩ  
R3 = 5.1KΩ  
V<sub>r</sub>= 2.5 V, V<sub>r</sub>=0.46 V

$$Rtrim\_up = \frac{18.944}{0.6} - 4.636 = 26.94 \, (K\Omega)$$

The typical value of R<sub>trim\_up</sub>

	5V	12V	24V
Trim up (%)		R <sub>trim_up</sub> (KΩ)	
1%	112.70	153.23	165.70
2%	54.70	74.30	79.36
3%	35.37	47.99	50.58
4%	25.70	34.83	36.19
5%	19.90	26.94	27.56
6%	16.03	21.68	21.80
7%	13.27	17.92	17.69
8%	11.20	15.10	14.61
9%	9.59	12.90	12.21
10%	8.30	11.15	10.29



#### The value of R<sub>trim\_down</sub> defined as:

$$Rtrim\_down = \frac{R1 \times (Vo - Vr)}{Vo\_nom - Vo} - R2 (K\Omega)$$

Where:

 $R_{\text{trim\_down}}$  is the external resistor in K  $\Omega$ 

 $V_{o\_nom}$  is the nominal output voltage

 $V_{\circ}$  is the desired output voltage

R1, R2, R3 and V<sub>r</sub> are internal components

For example: to trim-down the output voltage of 12V module (CHB150-110S12) by 5% to 11.4V,  $R_{trim\_down}$  is calculated as follows:

 $V_{o_nom} - V_o = 12 - 11.4 = 0.6 V$ R1 = 9.1 KΩ R2 = 51 KΩ V\_r = 2.5 V

$$Rtrim_down = \frac{9.1 \times (11.4 - 2.5)}{0.6} - 51 = 83.98 (K\Omega)$$

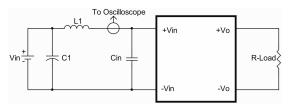
#### The typical value of R<sub>trim\_down</sub>

	- · · · · · · · · · · · · · · · · · · ·				
Trim down (%)	5V	12V	24V		
min down (%)		R <sub>trim_down</sub> (ΚΩ)			
1%	110.38	660.32	1671.67		
2%	52.38	300.11	775.83		
3%	33.05	180.04	477.22		
4%	23.38	120.00	327.92		
5%	17.58	83.98	238.33		
6%	13.71	59.97	178.61		
7%	10.95	42.82	135.95		
8%	8.88	29.95	103.96		
9%	7.27	19.95	79.07		
10%	5.98	11.94	59.17		

### 7. Input / Output Considerations

#### 7.1 Input Capacitance at the Power Module

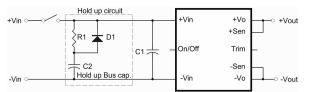
The converters must be connected to low AC source impedance. To avoid problems with loop stability source inductance should be low. Also, the input capacitors (Cin) should be placed close to the converter input pins to de-couple distribution inductance. However, the external input capacitors are chosen for suitable ripple handling capability. Low ESR capacitors are good choice. Circuit as shown as below represents typical measurement methods for reflected ripple current. C1 and L1 simulate a typical DC source impedance. The input reflected-ripple current is measured by current probe to oscilloscope with a simulated source Inductance (L1).



L1: 12uH C1: 220uF ESR<0.14ohm @100KHz Cin: 33uF ESR<0.2ohm @100KHz

### 7.2 Hold up Time

Hold up time is defined as the duration of time that DC/DC converter output will remain active following a loss of input power. To meet power supply interruptions, an external circuit is required, shown below.



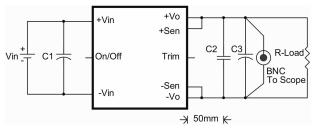
D1:200V/10A R1:100Ω/10W

C1:220uF/200V ESR<0.14Ω

C2	110Vin
Hold up time for 10ms	520uF
Hold up time for 30ms	1530uF



### 7.3 Output Ripple and Noise



C1:220uF/200V ESR<0.14Ω

C2: 1uF/1210 ceramic capacitor

C3: 10uF solid tantalum capacitor

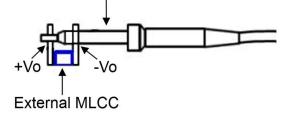
Output ripple and noise measured with 1uF ceramic capacitor across output and 10uF solid tantalum for all models. A 20 MHz bandwidth oscilloscope is normally used for the measurement.

The conventional ground clip on an oscilloscope probe should never be used in this kind of measurement. This clip, when placed in a field of radiated high frequency energy, acts as an antenna or inductive pickup loop, creating an extraneous voltage that is not part of the output noise of the converter.



Another method is shown in below, in case of coaxialcable/BNC is not available. The noise pickup is eliminated by pressing scope probe ground ring directly against the -Vout terminal while the tip contacts the +Vout terminal. This makes the shortest possible connection across the output terminals.

#### Ground Ring



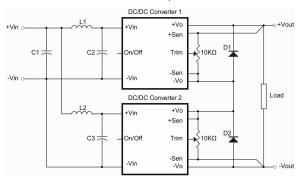
### 7.4 Output Capacitance

The CHB150-110S series converters provide unconditional stability with or without external capacitors. For good transient response, low ESR output capacitors should be located close to the point of load (<100mm). PCB design emphasizes low resistance and inductance tracks in consideration of high current applications. Output capacitors with their associated ESR values have an impact on loop stability and bandwidth. Cincon's converters are designed to work with load capacitance to see specifications.

## 8. Series and Parallel Operation

### 8.1 Series Operation

Series operation is possible by connecting the outputs two or more units. Connection is shown in below. The output current in series connection should be lower than the lowest rate current in each power module.



#### Simple Series Operation Connect Circuit

L1, L2: 1.0uH

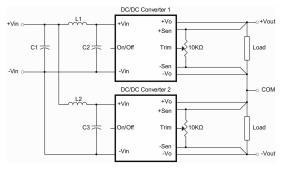
C1, C2, C3: 220uF/200V ESR<0.14 $\Omega$ 

#### Note:

- 1. If the impedance of input line is high, C1, C2, C3 capacitance must be more than above. Use more than two recommended capacitor above in parallel when ambient temperature becomes lower than -20°C.
- 2. Recommend schottky diode (D1, D2) be connected across the output of each series connected converter, so that if one converter shuts down for any reason, then the output stage won't be thermally overstressed. Without this external diode, the output stage of the shut-down converter could carry the load current provided by the other series converters, with its MOSFETs conducting through the body diodes. The MOSFETs could then be overstressed and fail. The external diode should be capable of handling the full load current for as long as the application is expected to run with any unit shut down.



Series for  $\pm$ output operation is possible by connecting the outputs two units, as shown in the schematic below.



Simple ±Output Operation Connect Circuit

L1, L2: 1.0uH

C1, C2, C3: 220uF/200V ESR<0.14Ω

#### Note:

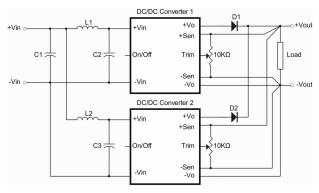
If the impedance of input line is high, C1, C2, C3 capacitance must be more than above. Use more than two recommended capacitor above in parallel when ambient temperature becomes lower than -20°C.

#### 8.2 Parallel Operation

The CHB150-110S series parallel operation is **not** possible.

#### 8.3 Redundant Operation

Parallel for redundancy operation is possible by connecting the units as shown in the schematic below. The current of each converter become unbalance by a slight difference of the output voltage. Make sure that the output voltage of units of equal value and the output current from each power supply does not exceed the rate current. Suggest use an external potentiometer to adjust output voltage from each power supply.



Simple Redundant Operation Connect Circuit L1, L2: 1.0uH C1, C2, C3: 220uF/200V ESR<0.14Ω

#### Note:

If the impedance of input line is high, C1, C2, C3 capacitance must be more than above. Use more than two recommended capacitor above in parallel when ambient temperature becomes lower than -20°C.



## 9. Thermal Design

### 9.1 Operating Temperature Range

The CHB150-110S series converters can be operated within a wide case temperature range of -40°C to 100°C. Consideration must be given to the derating curves when ascertaining maximum power that can be drawn from the converter. The maximum power drawn from open quarter brick models is influenced by usual factors, such as:

- Input voltage range
- Output load current
- Forced air or natural convection
- Heat sink optional

### 9.2 Convection Requirements for Cooling

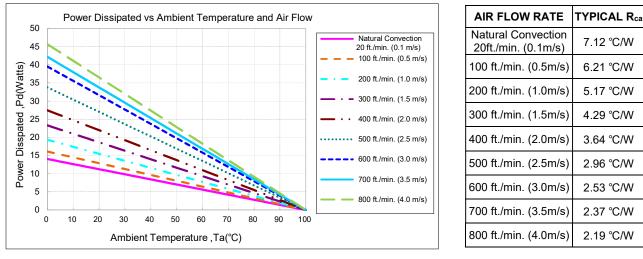
To predict the approximate cooling needed for the half brick module, refer to the power derating curves in **section 9.4**. These derating curves are approximations of the ambient temperatures and airflows required to keep the power module temperature below its maximum rating. Once the module is assembled in the actual system, the module's temperature should be monitored to ensure it does not exceed 100°C as measured at the center of the top of the case (thus verifying proper cooling).

### 9.3 Thermal Considerations

The power module operates in a variety of thermal environments; however, sufficient cooling should be provided to help ensure reliable operation of the unit. Heat is removed by conduction, convection, and radiation to the surrounding environment. The example is presented in **section 9.4**. The power output of the module should not be allowed to exceed rated power ( $V_{o_set} \times I_{o_max}$ ).

### 9.4 Power Derating

The operating case temperature range of CHB150-110S series is -40°C to +100°C. When operating the CHB150-110S series, proper derating or cooling is needed. The maximum case temperature under any operating condition should not exceed 100°C.



The following curve is the de-rating curve of CHB150-110S series without heat sink.



#### Example:

What is the minimum airflow necessary for a CHB150-110S12 operating at nominal line voltage, an output current of 12.5A, and a maximum ambient temperature of 40°C?

#### Solution:

Given:  $V_{in}$ =110 $V_{dc}$ ,  $V_o$ =12 $V_{dc}$ ,  $I_o$ =12.5A

**Determine Power dissipation (Pd):**  $P_d=P_i-P_0=P_0(1-\eta)/\eta$ ,  $P_d=12\times12.5\times(1-0.925)/0.925=12.16Watts$ 

Determine airflow: Given: Pd=12.16W and Ta=40°C

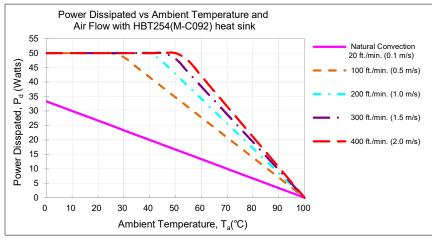
Check Power Derating curve: Minimum airflow=300 ft./min.

#### Verify:

Maximum temperature rise is  $\Delta T=P_d \times R_{ca}=12.16\times4.29=52.17^{\circ}C$ Maximum case temperature is  $T_c=T_a + \Delta T=92.17^{\circ}C<100^{\circ}C$ 

#### Where:

The  $R_{ca}$  is thermal resistance from case to ambient environment  $T_a$  is ambient temperature and  $T_c$  is case temperature



AIR FLOW RATE	TYPICAL R <sub>ca</sub>
Natural Convection 20ft./min. (0.1m/s)	3.00 °C/W
100 ft./min. (0.5m/s)	1.44 °C/W
200 ft./min. (1.0m/s)	1.17 °C/W
300 ft./min. (1.5m/s)	1.04 °C/W
400 ft./min. (2.0m/s)	0.95 °C/W

#### Example with heat sink HBT254 (M-C092):

What is the minimum airflow necessary for a CHB150-110S05 operating at nominal line voltage, an output current of 30A, and a maximum ambient temperature of 40°C?

#### Solution:

Given: Vin=110Vdc, Vo=5Vdc, Io=30A

Determine Power dissipation (P<sub>d</sub>): P<sub>d</sub>=Pi-Po=Po(1-η)/η, P<sub>d</sub>=5×30×(1-0.925)/0.925=12.16Watts

Determine airflow: Given: Pd=12.16W and Ta=40°C

Check above Power de-rating curve: Pd<20W, Natural Convection

#### Verify:

Maximum temperature rise is  $\Delta T=P_d \times R_{ca}=12.16 \times 3=36.48^{\circ}C$ 

Maximum case temperature is  $T_c=T_a + \Delta T = 76.48$ °C < 100°C

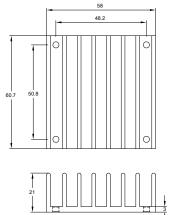
#### Where:

The  $R_{\mbox{\tiny ca}}$  is thermal resistance from case to ambient environment

 $T_{a}\xspace$  is ambient temperature and  $T_{c}\xspace$  is case temperature



### 9.5 Half Brick Heat Sinks:

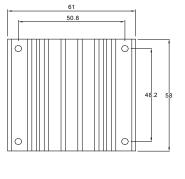


M-C308

HBL210(M-C308) G6620400201 Longitudinal Heat Sink

#### Rca:

3.90 °C/W (typ.), natural convection 1.74 °C/W (typ.), at 100LFM 1.33 °C/W (typ.), at 200LFM 1.12 °C/W (typ.), at 300LFM 0.97 °C/W (typ.), at 400LFM



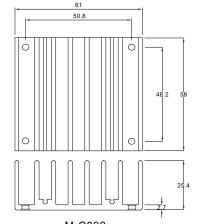


M-C091 HBT127 (M-C091) G6610120402

Transverse Heat Sink **Rca**:

4.70 °C/W (typ.), natural convection 2.89 °C/W (typ.), at 100LFM 2.30 °C/W (typ.), at 200LFM

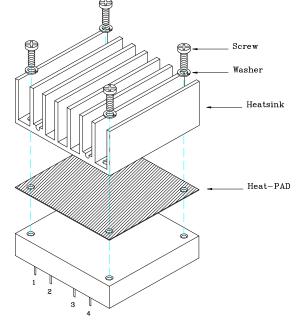
- 1.88 °C/W (typ.), at 300LFM
- 1.59 °C/W (typ.), at 400LFM



M-C092 HBT254 (M-C092) G6610130402 Transverse Heat Sink

#### Rca:

3.00 °C/W (typ.), natural convection 1.44 °C/W (typ.), at 100LFM 1.17 °C/W (typ.), at 200LFM 1.04 °C/W (typ.), at 300LFM 0.95 °C/W (typ.), at 400LFM



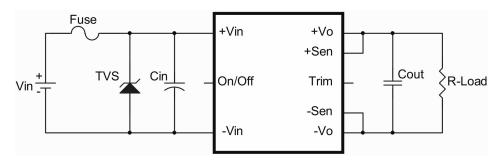
THERMAL PAD PH01: SZ 56.9\*60\*0.25 mm (G6135041091) SCREW K308W: SMP+SW M3\*8L (G75A1300322) Recommended torque 3Kgf-cm



## 10. Safety & EMC

### 10.1 Input Fusing and Safety Considerations

The CHB150-110S series converters have no internal fuse. In order to achieve maximum safety and system protection, always use an input line fuse. We recommended a 5A time delay fuse for all models. It is recommended that the circuit have a transient voltage suppressor diode (TVS) across the input terminal to protect the unit against surge or spike voltage and input reverse voltage (as shown).



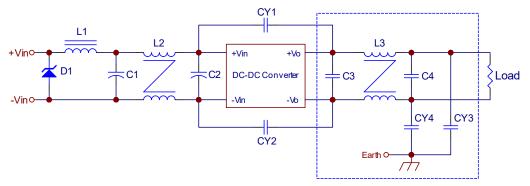
The external input capacitor (Cin) and transient voltage suppressor diode (TVS) are required if CHB150-110S series has to meet EN 61000-4-4, EN 61000-4-5.

The Cin recommended a 220uF/200V (RUBYCON YXF series) aluminum capacitor. And the TVS recommended 1.5KE180A (Littelfuse) for all models.

### 10.2 EMC Considerations

EMI Test standard: EN 50121-3-2 Conducted & Radiated Emission Test Condition: Input Voltage: 110Vdc, Output Load: Full Load

(1) EMI meet EN 50121-3-2:



**Connection Circuit for EMI Testing** 



Γ	Model Number			
	CHB150-110S05	CHB150-110S12	CHB150-110S24	
C1	220uF/200V	220uF/200V	220uF/200V	
C2	Aluminum cap. YXF series	Aluminum cap. YXF series	Aluminum cap. YXF series	
C3	1uF/50V	1uF/50V	1uF/50V	
C4	1210 X7R MLCC	1210 X7R MLCC	1210 X7R MLCC	
CY1				
CY2	2200pF/Y2	2200pF/Y2	2200pF/Y2	
CY3	4.7uF/50V *2	4.7uF/50V *2	4.7uF/50V *2	
CY4	1210 X7R MLCC	1210 X7R MLCC	1210 X7R MLCC	
D1	1.5KE180A Littelfuse	1.5KE180A Littelfuse	1.5KE180A Littelfuse	
L1	MICROMETALS T37-26 5uH, $\phi$ 0.5mm*1/ 14T	MICROMETALS T37-26 5uH, $\phi$ 0.5mm*1/ 14T	MICROMETALS T37-26 5uH, $\phi$ 0.5mm*1/ 14T	
L2	STEWARD 35T0711-00H 0.33mH, <i>ψ</i> 0.5mm*1/ 9T	STEWARD 35T0711-00H 0.33mH, ∉0.5mm*1/ 9T	STEWARD 35T0711-00H 0.33mH, ∉0.5mm*1/9T	
L3	VAKOS T18*12*6C 0.145mH, ∉0.8mm*2/ 5T	VAKOS T18*12*6C 0.145mH, ∉0.8mm*2/ 5T	VAKOS T18*12*6C 0.145mH, <i>ψ</i> 0.8mm*2/ 5T	

#### Note:

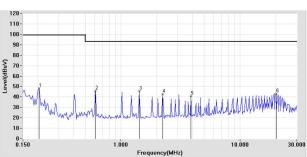
C1, C2 is RUBYCON YXF series aluminum capacitors or equivalent, CY1,2 is MURATA Y2 capacitor or equivalent

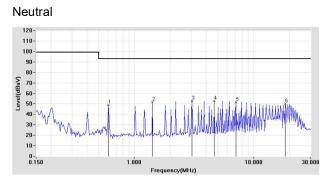


## Conducted Emission (Input):

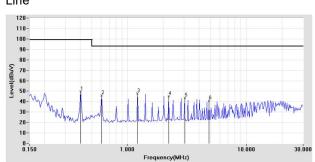
CHB150-110S05



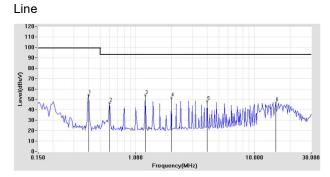




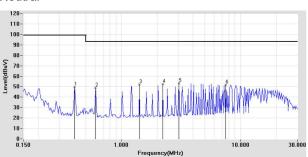
CHB150-110S12 Line

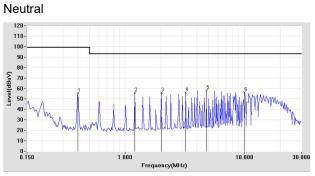


CHB150-110S24



Neutral

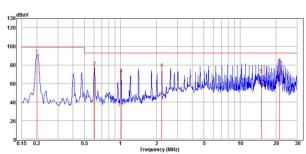


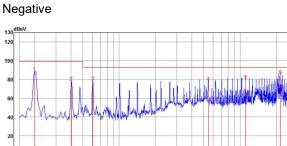




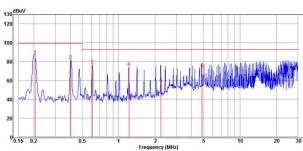
## Conducted Emission (Output):

CHB150-110S05 Positive

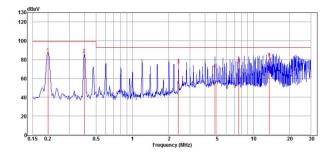




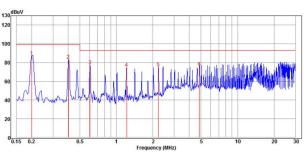




CHB150-110S24 Positive

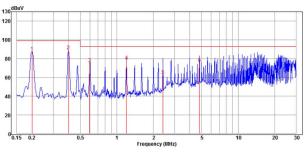


### Negative



2 Frequency (MHz)

### Negative

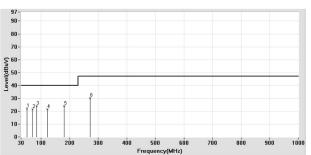


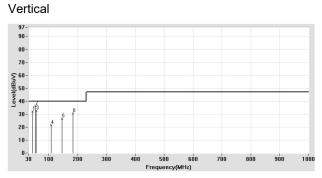
0.15



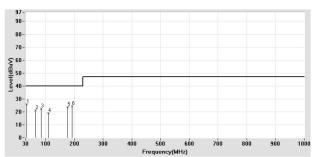
### **Radiated Emission:**

CHB150-110S05 Horizontal

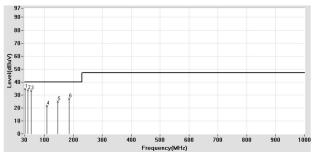




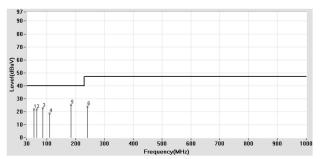
#### CHB150-110S12 Horizontal



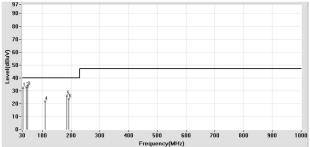
### Vertical



#### CHB150-110S24 Horizontal

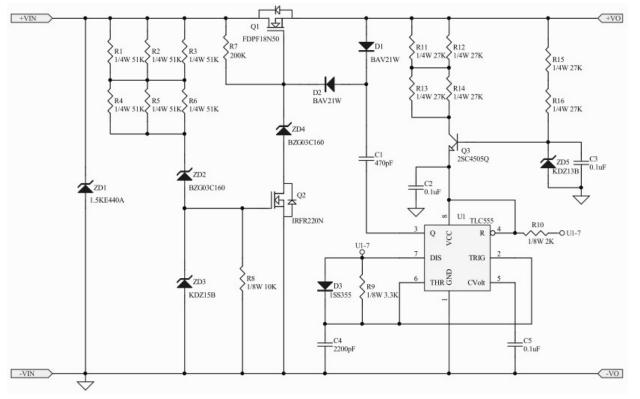


### Vertical





### 10.3 Suggested Configuration for RIA12 Surge Test



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#### Factory:

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